CNZ1021,CNZ1022,CNZ1023,CNA1009H
(ON1021, ON1022, ON1023, ON1024)

Photo Interrupters

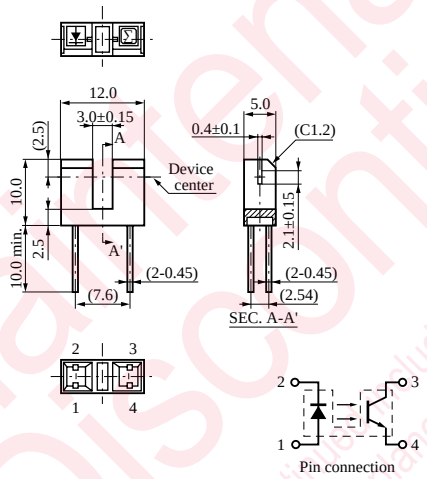
■ Overview

CNZ1021 series is a transmissive photosensor series in which a high efficiency GaAs infrared light emitting diode is used as the light emitting element, and a high sensitivity phototransistor is used as the light detecting element. The two elements are arranged so as to face each other, and objects passing between them are detected.

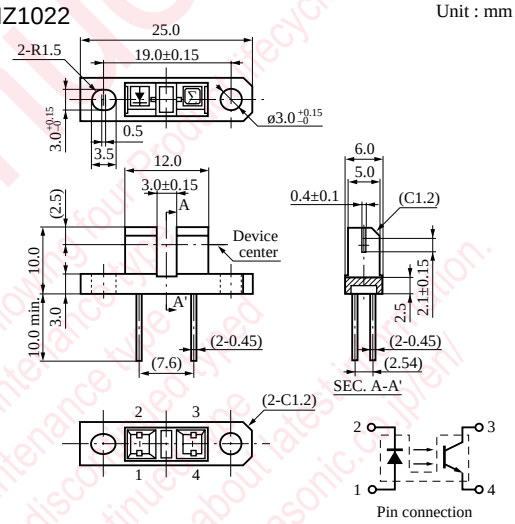
■ Features

- Position detection accuracy : 0.25 mm
- Gap width : 3 mm (CNZ1021, CNZ1022, CNZ1023)
  5 mm (CNA1009H)
- The type directly attached to PCB CNZ1021
  Screw-fastened type (both sides) CNZ1022
  Screw-fastened type (one side) CNZ1023
  The type directly attached to PCB CNA1009H
  (with a positioning pins)

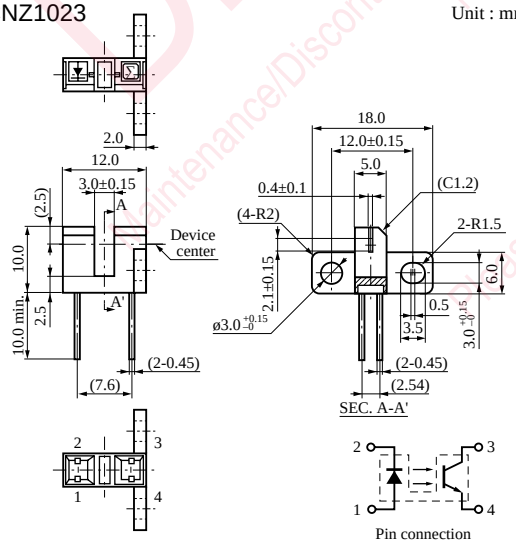
CNZ1021 Unit : mm



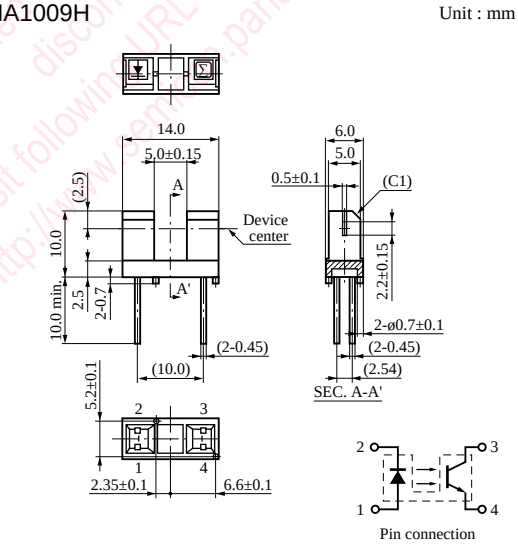
CNZ1022 Unit : mm



CNZ1023 Unit : mm



CNA1009H Unit : mm



(Note) 1. Tolerance unless otherwise specified is ±0.3.
2. ( ) Dimension is reference.

Note) The part numbers in the parenthesis show conventional part number.

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■ Absolute Maximum Ratings (Ta = 25˚C)

Parameter		Symbol	Ratings	Unit
Input (Light emitting diode)	Reverse voltage (DC)	V_R	5	V
	Forward current (DC)	I_F	50	mA
	Power dissipation	P_D *1	75	mW
Output (Photo transistor)	Collector current	I_C	20	mA
	Collector to emitter voltage	V_{CEO}	30	V
	Emitter to collector voltage	V_{ECO}	5	V
	Collector power dissipation	P_C *2	100	mW
Temperature	Operating ambient temperature	T_{opr}	–25 to +85	˚C
	Storage temperature	T_{stg}	–40 to +100	˚C

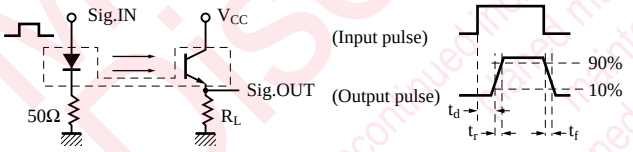
*1 Input power derating ratio is 1.0 mW/˚C at Ta ≥ 25˚C.

*2 Output power derating ratio is 1.33 mW/˚C at Ta ≥ 25˚C.

■ Electrical Characteristics (Ta = 25˚C)

Parameter		Symbol	Conditions	min	typ	max	Unit
Input characteristics	Forward voltage (DC)	V_F	I_F = 20mA		1.25	1.4	V
	Reverse current (DC)	I_R	V_R = 3V			10	µA
Output characteristics	Collector cutoff current	I_{CEO}	V_{CE} = 10V		10	200	nA
Transfer characteristics	Collector current	I_C	V_{CC} = 5V, I_F = 20mA, R_L = 100Ω	0.5		15	mA
	Collector to emitter saturation voltage	$V_{CE(sat)}$	I_F = 40mA, I_C = 1mA			0.4	V
	Response time	t_r , t_f *	V_{CC} = 5V, I_C = 1mA, R_L = 100Ω		5		µs

* Switching time measurement circuit



t_d: Delay time

t_r: Rise time (Time required for the collector current to increase from 10% to 90% of its final value)

t_f: Fall time (Time required for the collector current to decrease from 90% to 10% of its initial value)

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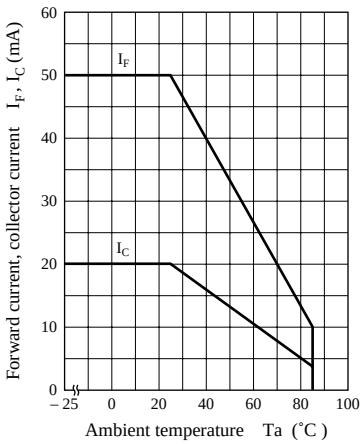
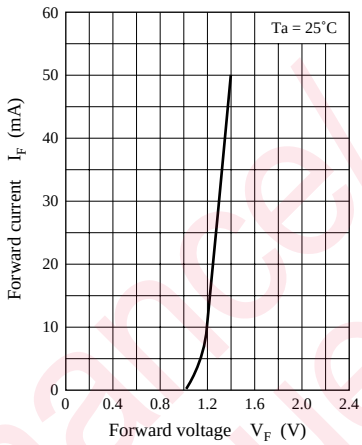
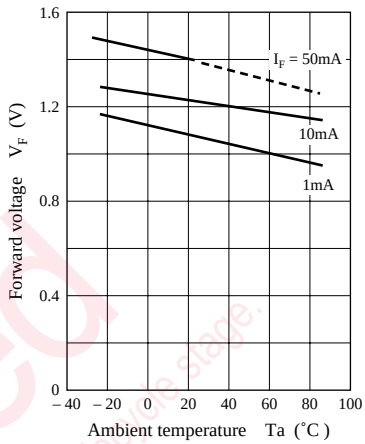
I_F , I_C — Ta



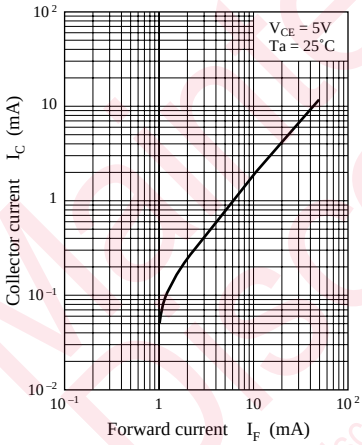
I_F — V_F



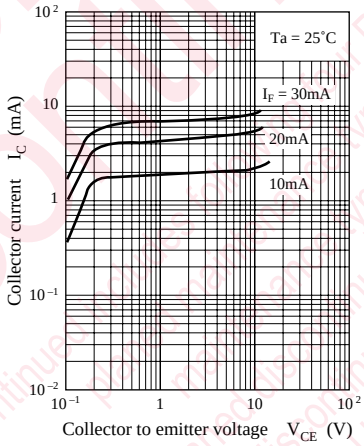
V_F — Ta



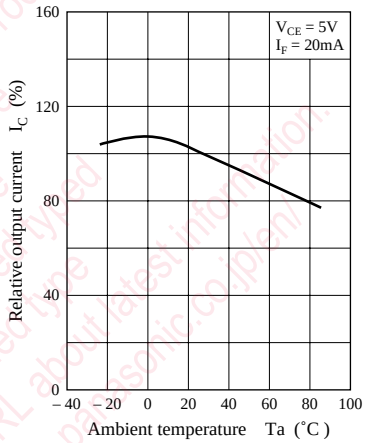
I_C — I_F



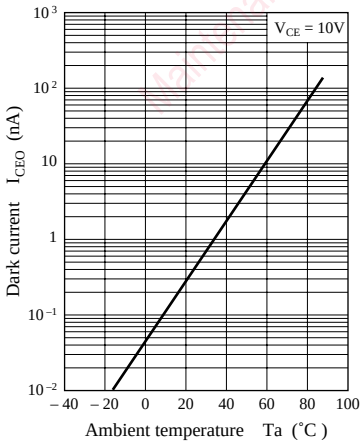
I_C — V_{CE}



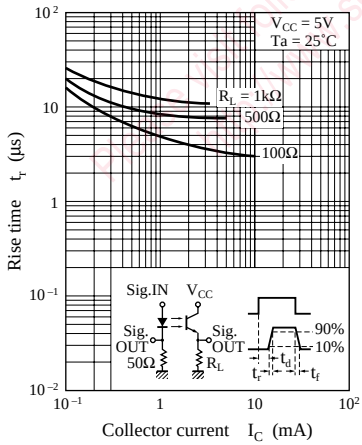
I_C — Ta



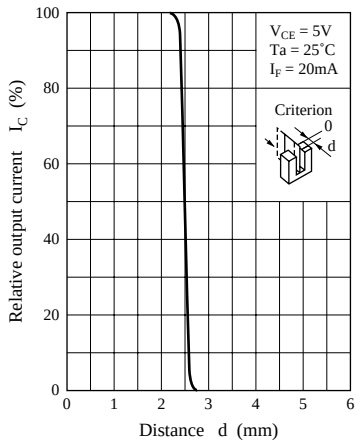
I_{CEO} — Ta



t_r — I_C



I_C — d



Maintenance/Discontinued
Discontinued
Maintenance/Discontinued
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⚠DANGER

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